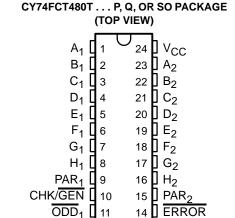
- **Function, Pinout, and Drive Compatible** With FCT and F Logic
- Reduced V_{OH} (Typically = 3.3 V) Versions of Equivalent FCT Functions
- **Edge-Rate Control Circuitry for** Significantly Improved Noise Characteristics
- Ioff Supports Partial-Power-Down Mode Operation
- **Matched Rise and Fall Times**
- Fully Compatible With TTL Input and **Output Logic Levels**
- Two 8-Bit Parity Generators/Checkers
- **Open-Drain Active-Low Parity-Error Output**
- **Expandable for Larger Word Widths**
- **ESD Protection Exceeds JESD 22**
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)
- CY54FCT480T
 - 32-mA Output Sink Current
 - 12-mA Output Source Current
- CY74FCT480T
 - 64-mA Output Sink Current
 - 32-mA Output Source Current

description

The 'FCT480T devices are high-speed, dual, 8-bit parity generators/checkers. Each parity generator/checker accepts eight data bits and one parity bit as inputs, and generates a sum and parity-error (ERROR) output. These devices can be used in odd-parity systems. ERROR is an open-drain output designed for easy expansion of

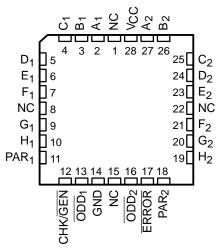


CY54FCT480T...L PACKAGE (TOP VIEW)

12

GND

13 ODD₂



NC - No internal connection

the word width by a wired-OR connection of several 'FCT480T devices. Because no additional logic is needed, the parity-generation or parity-checking times remain the same as for an individual 'FCT480T device.

These devices are fully specified for partial-power-down applications using Ioff. The Ioff circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.



testing of all parameters.

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



ORDERING INFORMATION

TA	PAC	KAGE [†]	SPEED (ns)	ORDERABLE PART NUMBER	TOP-SIDE MARKING
	DIP – P	Tube	6.1	CY74FCT480BTPC	CY74FCT480BTPC
	QSOP - Q	Tape and reel	6.1	CY74FCT480BTQCT	FCT480B
-40°C to 85°C	SOIC - SO	Tube	6.1	CY74FCT480BTSOC	FCT480B
-40°C to 85°C	3010 - 30	Tape and reel		CY74FCT480BTSOCT	FC1460B
	DIP – P	Tube	7.5	CY74FCT480ATPC	CY74FCT480ATPC
	QSOP - Q	Tape and reel	7.5	CY74FCT480ATQCT	FCT480A
–55°C to 125°C	LCC – L	Tube	7	CY54FCT480BTLMB	

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

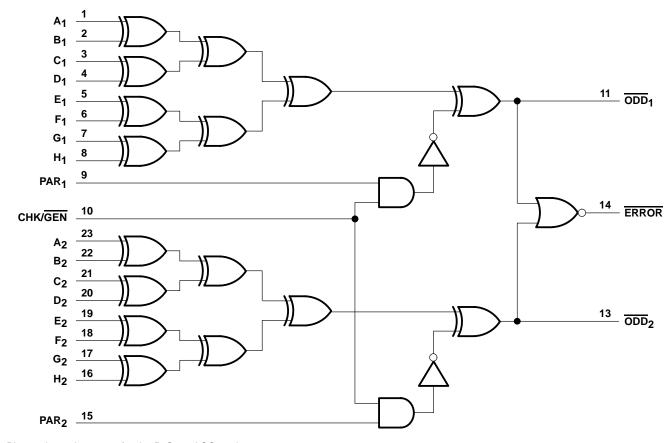
FUNCTION TABLE

	INPUT	'S				OUTPUT	S
A ₁ -H ₁	A ₂ -H ₂	CHK/GEN	PAR ₁	PAR ₂	ODD ₁	ODD ₂	ERROR
		Н	Н	Н	L	L	Н
	Number of	Н	L	Н	Н	L	L
	A ₂ -H ₂ inputs,	Н	Н	L	L	Н	L
	high is even	Н	L	L	Н	Н	L
Number of		L	Х	Χ	Н	Н	L
A ₁ -H ₁ inputs, high is even		Н	Н	Н	L	Н	L
Ingilio ovoli	Number of	Н	L	Н	Н	Н	L
	inputs A2-H2,	Н	Н	L	L	L	Н
	high is odd	Н	L	L	Н	L	L
		L	Χ	Χ	Н	L	L
		Н	Н	Н	Н	L	L
	Number of	Н	L	Н	L	L	Н
	A ₂ –H ₂ inputs,	Н	Н	L	Н	Н	L
	high is even	Н	L	L	L	Н	L
Number of		L	X	Χ	L	Н	L
A ₁ -H ₁ inputs, high is odd		Н	Н	Н	Н	Н	L
nign is odd	Number of	Н	L	Н	L	Н	L
	A ₂ -H ₂ inputs,	Н	Н	L	Н	L	L
	high is odd	Н	L	L	L	L	Н
		L	Χ	Χ	L	L	Н

H = High logic level, L = Low logic level, X = Don't care



logic diagram



Pin numbers shown are for the P, Q, and SO packages.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage range to ground potential	
DC output voltage range	
DC output current (maximum sink current/pin)	120 mA
Package thermal impedance, θ _{JA} (see Note 1): P package	67°C/W
(see Note 2): Q package	61°C/W
(see Note 2): SO package	46°C/W
Ambient temperature range with power applied, T _A	−65°C to 135°C
Storage temperature range, T _{stq}	−65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The package thermal impedance is calculated in accordance with JESD 51-3.

2. The package thermal impedance is calculated in accordance with JESD 51-7.



CY54FCT480T, CY74FCT480T DUAL 8-BIT PÁRITY GENERATORS/CHECKERS

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recommended operating conditions (see Note 3)

		CY54FCT480T			CY	UNIT		
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
VCC	Supply voltage	4.5	5	5.5	4.75	5	5.25	V
VIH	High-level input voltage	2			2			V
VIL	Low-level input voltage			0.8			0.8	V
loh	High-level output current			-12			-32	mA
l _{OL}	Low-level output current			32			64	mA
T _A	Operating free-air temperature	-55		125	-40		85	°C

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DADAMETED	TEGT COMPITIONS	CY	′54FCT48	30T	CY			
PARAMETER	TEST CONDITIONS	MIN	TYP†	MAX	MIN	TYP	MAX	UNIT
Maria	$V_{CC} = 4.5 \text{ V}, \qquad I_{IN} = -18 \text{ mA}$		-0.7	-1.2				V
VIK	V _{CC} = 4.75 V, I _{IN} = -18 mA					-0.7	-1.2	
	$V_{CC} = 4.5 \text{ V}, \qquad I_{OH} = -12 \text{ mA}$	2.4	3.3					
Voн	V _{CC} = 4.75 V				2.4	3.3		V
0.1	$V_{CC} = 4.75 \text{ V}$ $I_{OH} = -32 \text{ mA}$				2			
\/a.	$V_{CC} = 4.5 \text{ V}, \qquad I_{OL} = 32 \text{ mA}$		0.3	0.55				V
VOL	$V_{CC} = 4.75 \text{ V}, \qquad I_{OL} = 64 \text{ mA}$					0.3	0.55	V
V_{hys}	All inputs		0.2			0.2		V
	$V_{CC} = 5.5 \text{ V}, \qquad V_{IN} = V_{CC}$			5				
łį	$V_{CC} = 5.25 \text{ V}, \qquad V_{IN} = V_{CC}$						5	μΑ
1	$V_{CC} = 5.5 \text{ V}, \qquad V_{IN} = 2.7 \text{ V}$			±1				
lіН	$V_{CC} = 5.25 \text{ V}, \qquad V_{IN} = 2.7 \text{ V}$						±1	μΑ
1	$V_{CC} = 5.5 \text{ V}, \qquad V_{IN} = 0.5 \text{ V}$			±1				μΑ
I⊫	$V_{CC} = 5.25 \text{ V}, \qquad V_{IN} = 0.5 \text{ V}$						±1	μΑ
l _{off}	$V_{CC} = 0 \text{ V}, \qquad V_{OUT} = 4.5 \text{ V}$			±1			±1	μΑ
los‡	$V_{CC} = 5.5 \text{ V}, \qquad V_{OUT} = 0 \text{ V}$	-60	-120	-225				mA
iOS ⁺	$V_{CC} = 5.25 \text{ V}, \qquad V_{OUT} = 0 \text{ V}$				-60	-120	-225	ША
10711	$V_{CC} = 5.5 \text{ V}, \qquad V_{OUT} = 2.7 \text{ V}$			10				μΑ
lozh	$V_{CC} = 5.25 \text{ V}, \qquad V_{OUT} = 2.7 \text{ V}$						10	μΑ
107	$V_{CC} = 5.5 \text{ V}, \qquad V_{OUT} = 0.5 \text{ V}$			-10				μΑ
lozl	$V_{CC} = 5.25 \text{ V}, \qquad V_{OUT} = 0.5 \text{ V}$						-10	μΑ
loo	$V_{CC} = 5.5 \text{ V}, \qquad V_{IN} \le 0.2 \text{ V}, \qquad V_{IN} \ge V_{CC} - 0.2 \text{ V}$		0.1	0.2				
Icc	$V_{CC} = 5.25 \text{ V}, \qquad V_{IN} \le 0.2 \text{ V}, \qquad V_{IN} \ge V_{CC} - 0.2 \text{ V}$					0.1	0.2	mA
Aloo	$V_{CC} = 5.5 \text{ V}, V_{IN} = 3.4 \text{ V}$, $f_1 = 0$, Outputs open		0.5	2				mA
∆ICC	$V_{CC} = 5.25 \text{ V}, V_{IN} = 3.4 \text{ V}$, $f_1 = 0$, Outputs open					0.5	2	IIIA

[†] Typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.



[‡] Not more than one output should be shorted at a time. Duration of short should not exceed one second. The use of high-speed test apparatus and/or sample-and-hold techniques are preferable to minimize internal chip heating and more accurately reflect operational values. Otherwise, prolonged shorting of a high output can raise the chip temperature well above normal and cause invalid readings in other parametric tests. In any sequence of parameter tests, IOS tests should be performed last.

Per TTL-driven input (VIN = 3.4 V); all other inputs at VCC or GND

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted) (continued)

DADAMETED		TEST CONDITIONS					CY	0T	UNIT	
PARAMETER		TEST CONDITION	MIN	TYP [†]	MAX	MIN	TYP [†]	MAX	UNII	
ICCD¶	$V_{CC} = 5.5 \text{ V}$, Outp One bit switching a $V_{IN} \le 0.2 \text{ V}$ or V_{IN}	at 50% duty cycle,			0.06	0.12				mA/
ICCD"	V_{CC} = 5.25 V, Out One bit switching a $V_{IN} \le 0.2$ V or V_{IN}	at 50% duty cycle,						0.06	0.12	MHz
		One bit switching at f ₁ = 2.5 MHz	$V_{IN} \le 0.2 \text{ V or}$ $V_{IN} \ge V_{CC} - 0.2 \text{ V}$		0.7	1.4				
	V _{CC} = 5.5 V, f ₀ = 0 MHz, Outputs open	at 50% duty cycle	V _{IN} = 3.4 V or GND		1	2.4				
		en 16 bits switching at f ₁ = 2.5 MHz	$V_{IN} \le 0.2 \text{ V or}$ $V_{IN} \ge V_{CC} - 0.2 \text{ V}$		2.5	5				
IC#		at 50% duty cycle	V _{IN} = 3.4 V or GND		6.5	21				mA
10"		One bit switching at f ₁ = 2.5 MHz	$V_{IN} \le 0.2 \text{ V or}$ $V_{IN} \ge V_{CC} - 0.2 \text{ V}$					0.7	1.4	IIIA
	$V_{CC} = 5.25 \text{ V},$ $f_0 = 0 \text{ MHz},$	at 50% duty cycle	V _{IN} = 3.4 V or GND					1	2.4	
	Outputs open	16 bits switching at f ₁ = 2.5 MHz	$V_{IN} \le 0.2 \text{ V or}$ $V_{IN} \ge V_{CC} - 0.2 \text{ V}$					2.5	5	
		at 50% duty cycle	V _{IN} = 3.4 V or GND					6.5	21	
C _i					5	10		5	10	pF
Co					9	12		9	12	pF

[†] Typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

Where:

I_C= Total supply current

ICC= Power-supply current with CMOS input levels

 ΔI_{CC} = Power-supply current for a TTL high input ($V_{IN} = 3.4 \text{ V}$)

DH= Duty cycle for TTL inputs high

N_T= Number of TTL inputs at D_H

I_{CCD}= Dynamic current caused by an input transition pair (HLH or LHL)

 f_0 = Clock frequency for registered devices, otherwise zero

f₁= Input signal frequency

 N_1 = Number of inputs changing at f_1

All currents are in milliamperes and all frequencies are in megahertz.

|| Values for these conditions are examples of the I_{CC} formula.



This parameter is derived for use in total power-supply calculations.

 $^{^{\#}}$ IC=ICC + \triangle ICC \times DH \times NT + ICCD (f₀/2 + f₁ \times N₁)

CY54FCT480T, CY74FCT480T DUAL 8-BIT PARITY GENERATORS/CHECKERS

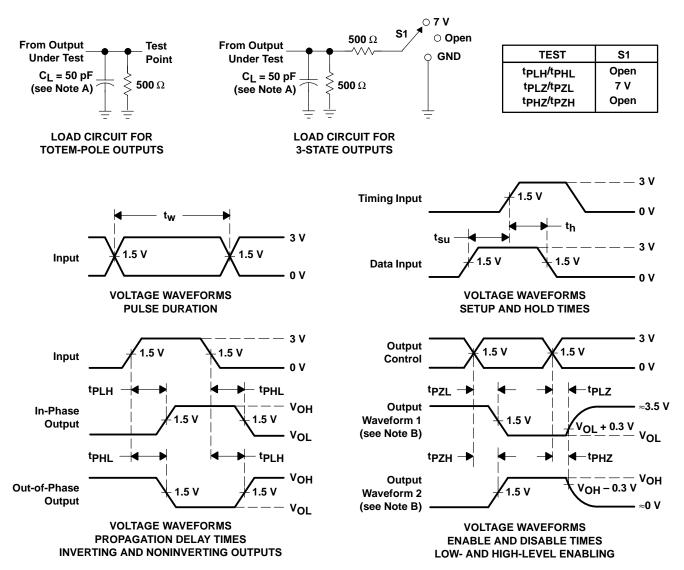
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switching characteristics over operating free-air temperature range (see Figure 1)

PARAMETER	FROM	то	CY74FCT	480AT	CY54FCT	480BT	CY74FC1	480BT	UNIT	
PARAMETER	(INPUT)	(OUTPUT)	MIN	MAX	MIN	MAX	MIN	MAX	UNIT	
t _{PLH}	А	ODD		7.5		7		6.1	ns	
t _{PHL}	Α	(see Figure 1)		7		6.6		6.1	115	
t _{PLH}	CHK/ GEN	ODD		6.5		6.3		5.9	ns	
t _{PHL}	CHNGEN	(see Figure 1)		7.5		7.4		5.9	115	
t _{PLH} †	Α	ERROR		7		7		6.1	no	
t _{PHL}	A	(see Figure 2)		8.5		8.1		6.5	ns	
^t PLH	CHK/ GEN	ERROR		7.5		7.1		5.7	ns	
tpHL	CHNGEN	(see Figure 2)		7		6.9		5.5	115	

 $^{^{\}dagger}$ tpLH is measured up to VOUT = VOL + 0.3 V.

PARAMETER MEASUREMENT INFORMATION

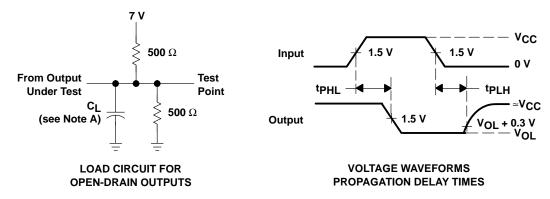


NOTES: A. C_I includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms

PARAMETER MEASUREMENT INFORMATION FOR OPEN-DRAIN OUTPUTS



NOTES: A. C_L includes probe and jig capacitance.

- B. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, $Z_O = 50 \Omega$, $t_f \leq 3$ ns. $t_f \leq 3$ ns.
- C. The outputs are measured one at a time with one input transition per measurement.

Figure 2. Load Circuit and Voltage Waveforms



PACKAGE OPTION ADDENDUM

9-Mar-2021

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
CY54FCT480BTLMB	ACTIVE	LCCC	FK	28	1	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	CY54FCT 480BTLMB	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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